

# FDP7030BLS / FDB7030BLS

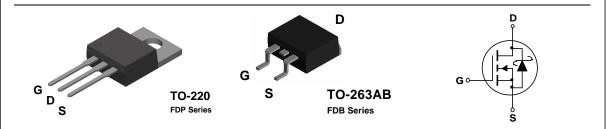
# 30V N-Channel PowerTrench<sup>o</sup> SyncFET<sup>™</sup>

## **General Description**

This MOSFET is designed to replace a single MOSFET and parallel Schottky diode in synchronous DC:DC power supplies. This 30V MOSFET is designed to maximize power conversion efficiency, providing a low  $R_{DS(ON)}$  and low gate charge. The FDP7030BLS includes an integrated Schottky diode using Fairchild's monolithic SyncFET technology. The performance of the FDP7030BLS as the low-side switch in a synchronous rectifier is indistinguishable from the performance of the FDP7030BL in parallel with a Schottky diode.

### Features

- 56 A, 30 V.  $R_{DS(ON)} = 10.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 16.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Includes SyncFET Schottky body diode
- Low gate charge (15nC typical)
- High performance trench technology for extremely low R<sub>DS(ON)</sub> and fast switching
- High power and current handling capability



## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

| Symbol                            | Parameter                                     |  |                  | Ratings     | Units  |  |
|-----------------------------------|---|--|------------------|-------------|--|--|
| V <sub>DSS</sub>                  | Drain-Sourc                                   | e Voltage                                  |                  | 30          | V  |  |
| V <sub>GSS</sub>                  | Gate-Source Voltage                           |  |                  | ±20         | V  |  |
| I <sub>D</sub>                    | Drain Currer                                  | nt – Continuous                            | (Note 1)         | 56          |  |  |
|                                   |   | <ul> <li>Pulsed</li> </ul>                 | (Note 1)         | 160         | A  |  |
| P <sub>D</sub>                    | Total Power Dissipation @ $T_c = 25^{\circ}C$ |  |                  | 65          | W  |  |
|                                   |   |  | 0.43             | W/°C        |  |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating a                                   | nd Storage Junction Te                     | emperature Range | -65 to +100 | °C   |  |
| TL                                |   | ad temperature for sol<br>se for 5 seconds | dering purposes, | 275         | °C   |  |
| Therma                            | I Charact                                     | teristics                                  |                  |             |  |  |
| R <sub>eJC</sub>                  | Thermal Re                                    | sistance, Junction-to-                     | Case             | 2.3         | °C/W   |  |
| R <sub>eja</sub>                  | Thermal Resistance, Junction-to-Ambient       |  |                  | 62.5 °(     |  |  |
| Packag                            | e Marking                                     | g and Orderin                              | g Information    |             | Letter and the second s |  |
| Device Marking                    |   | Device                                     | Reel Size        | Tape width  | Quantity   |  |
| FDB7030BLS                        |   | FDB7030BLS                                 | 13"              | 24mm        | 800 units  |  |

FDB7030BLSFDB7030BLS13"24mm800 unitsFDP7030BLSFDP7030BLSTuben/a45

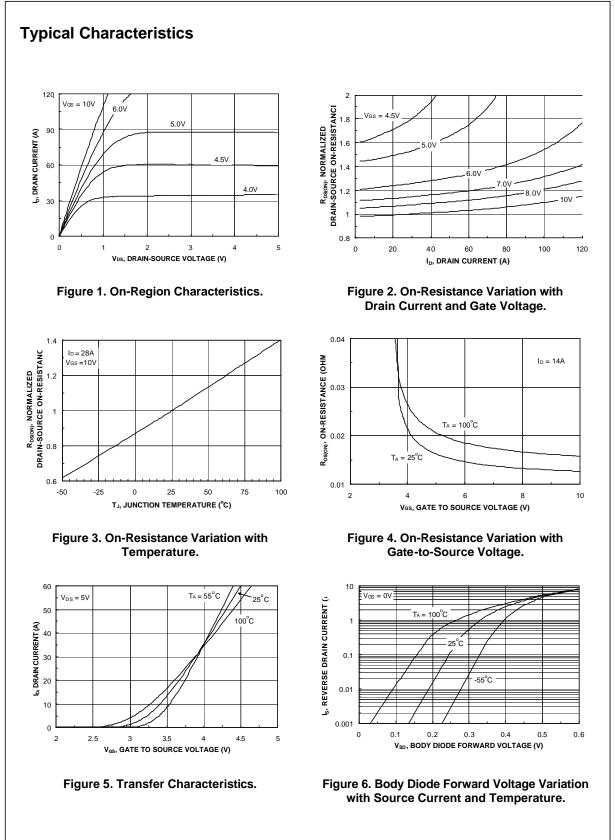
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| Symbol  | Parameter  | <b>Test Conditions</b>  | Min | Тур                                 | Max                         | Units                            |
|---|--|---|-----|-------------------------------------|-----------------------------|----------------------------------|
| Off Cha   | racteristics   |   |     |                                     |                             |                                  |
| BV <sub>DSS</sub>   | Drain–Source Breakdown Voltage   | $V_{GS} = 0 V$ , $I_{D} = 1 mA$   | 30  |                                     |                             | V                                |
| <u>ΔBV<sub>DSS</sub></u><br>ΔT <sub>J</sub>   | Breakdown Voltage Temperature<br>Coefficient   | $I_{D} = 10$ mA, Referenced to 25°C   |     | 22                                  |                             | mV/°C                            |
| I <sub>DSS</sub>  | Zero Gate Voltage Drain Current  | $V_{DS} = 24 \text{ V},  V_{GS} = 0 \text{ V}$  |     |                                     | 500                         | μA                               |
| IGSSF   | Gate-Body Leakage, Forward   | $V_{GS} = 20 \text{ V},  V_{DS} = 0 \text{ V}$  |     |                                     | 100                         | nA                               |
| GSSR  | Gate-Body Leakage, Reverse   | $V_{GS} = -20 V$ $V_{DS} = 0 V$   |     |                                     | -100                        | nA                               |
| On Cha  | acteristics (Note 2)   |   | •   | •                                   |                             |                                  |
| V <sub>GS(th)</sub>   | Gate Threshold Voltage   | $V_{DS} = V_{GS}, \qquad I_D = 1 \text{ mA}$  | 1   | 2.3                                 | 3                           | V                                |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$  | Gate Threshold Voltage<br>Temperature Coefficient  | $I_D = 1$ mA, Referenced to 25°C  |     | -4.4                                |                             | mV/°C                            |
| R <sub>DS(on)</sub>   | Static Drain–Source<br>On–Resistance   |   |     | 8.6<br>13.2<br>12.4                 | 10.5<br>16.5<br>16.5        | mΩ                               |
| I <sub>D(on)</sub>  | On–State Drain Current   | $V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$  | 50  |                                     |                             | Α                                |
| <b>g</b> <sub>FS</sub>  | Forward Transconductance   | $V_{DS} = 5 V$ , $I_{D} = 28 A$   |     | 47                                  |                             | S                                |
| Dynami  | c Characteristics  |   |     |                                     |                             | <u> </u>                         |
| C <sub>iss</sub>  | Input Capacitance  | $V_{DS} = 15 V$ , $V_{GS} = 0 V$ ,  |     | 1708                                |                             | pF                               |
| C <sub>oss</sub>  | Output Capacitance   | f = 1.0 MHz   |     | 474                                 |                             | pF                               |
| <u>^</u>  |  | -   |     | 134                                 |                             | pF                               |
| Crss  | Reverse Transfer Capacitance   |   |     | 134                                 |                             | рг                               |
|   | •  |   |     | 134                                 |                             | рг                               |
| Switchir  |  | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1 A,   |     | 134                                 | 21                          | ns                               |
|   | ng Characteristics (Note 2)  | $V_{DS} = 15 \text{ V}, \qquad I_D = 1 \text{ A}, \\ V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$  |     |                                     | 21<br>16                    |                                  |
| Switchir<br>t <sub>d(on)</sub><br>t <sub>r</sub>  | Turn-On Delay Time   | 50 , 5 ,  |     | 11                                  |                             | ns                               |
| <b>Switchir</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d</sub> (off)   | <b>G Characteristics</b> (Note 2)<br>Turn–On Delay Time<br>Turn–On Rise Time   | 50 , 5 ,  |     | 11<br>8                             | 16                          | ns<br>ns                         |
| <b>Switchir</b><br>t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off</sub> )<br>t <sub>f</sub>                                   | <b>G Characteristics</b> (Note 2)<br>Tum–On Delay Time<br>Tum–On Rise Time<br>Tum–Off Delay Time   | 50 , 5 ,  |     | 11<br>8<br>30                       | 16<br>48                    | ns<br>ns<br>ns                   |
|   | <b>IDENTIFY and Set UP Characteristics</b> (Note 2)<br>Tum–On Delay Time<br>Tum–On Rise Time<br>Tum–Off Delay Time<br>Tum–Off Fall Time  | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$  |     | 11<br>8<br>30<br>16                 | 16<br>48<br>29              | ns<br>ns<br>ns<br>ns             |
| Switchir           t <sub>d(an)</sub> tr           t_d(off)           tf           Qg           Qgs                                 | g Characteristics       (Note 2)         Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge   | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$<br>$V_{DS} = 15 \text{ V}, \qquad I_D = 28 \text{ A}$  |     | 11<br>8<br>30<br>16<br>15           | 16<br>48<br>29              | ns<br>ns<br>ns<br>ns<br>nC       |
| Switchin           t <sub>d(on)</sub> tr           d <sub>d(off</sub> )           tf           Qg           Qgs           Qgd       | g Characteristics (Note 2)         Turn-On Delay Time         Turn-On Rise Time         Turn-Off Delay Time         Turn-Off Fall Time         Total Gate Charge         Gate-Source Charge         Gate-Drain Charge  | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 15 \text{ V}, \qquad I_D = 28 \text{ A}$ $V_{GS} = 5 \text{ V}$  |     | 11<br>8<br>30<br>16<br>15<br>7      | 16<br>48<br>29              | ns<br>ns<br>ns<br>nC<br>nC       |
| Switchin           t <sub>d(on)</sub> tr           d <sub>d(off</sub> )           tf           Qg           Qgs           Qgd       | g Characteristics       (Note 2)         Tum-On Delay Time         Tum-On Rise Time         Tum-Off Delay Time         Tum-Off Fall Time         Total Gate Charge         Gate-Source Charge  | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 15 \text{ V}, \qquad I_D = 28 \text{ A}$ $V_{GS} = 5 \text{ V}$ and Maximum Ratings  |     | 11<br>8<br>30<br>16<br>15<br>7      | 16<br>48<br>29              | ns<br>ns<br>ns<br>nC<br>nC       |
| Switchir           t <sub>d(on)</sub> tr           t_d(off)           tf           Qg           Qgs           Qgd           Drain–S | Characteristics (Note 2)     Tum-On Delay Time     Tum-On Rise Time     Tum-Off Delay Time     Tum-Off Fall Time     Total Gate Charge     Gate-Source Charge     Gate-Drain Charge     Ource Diode Characteristics a     Maximum Continuous Drain-Source     Drain-Source Diode Forward   | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 15 \text{ V}, \qquad I_D = 28 \text{ A}$ $V_{GS} = 5 \text{ V}$ <b>and Maximum Ratings</b> Diode Forward Current $V_{GS} = 0 \text{ V},  I_S = 3.5 \text{ A}  (\text{Note 1})$ |     | 11<br>8<br>30<br>16<br>15<br>7<br>5 | 16<br>48<br>29<br>21        | ns<br>ns<br>ns<br>nC<br>nC<br>nC |
| Switchir<br>$t_{d(on)}$<br>$t_r$<br>$t_d(off)$<br>$t_f$<br>$Q_g$<br>$Q_{gs}$<br>$Q_{gd}$<br>Drain–S<br>$l_s$                        | g Characteristics       (Note 2)         Turn-On Delay Time       Turn-On Rise Time         Turn-Off Delay Time       Turn-Off Fall Time         Total Gate Charge       Gate-Source Charge         Gate-Drain Charge       Ource Diode Characteristics at Maximum Continuous Drain-Source | $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 15 \text{ V}, \qquad I_D = 28 \text{ A}$ $V_{GS} = 5 \text{ V}$ and Maximum Ratings Diode Forward Current  |     | 11<br>8<br>30<br>16<br>15<br>7<br>5 | 16<br>48<br>29<br>21<br>3.5 | ns<br>ns<br>ns<br>nC<br>nC<br>nC |

Notes:

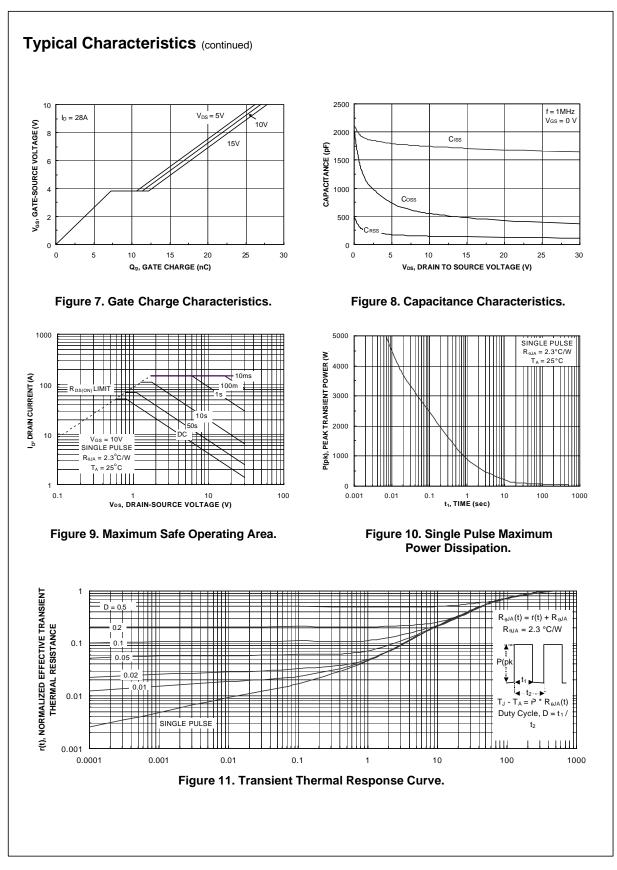
Pulse Test: Pulse Width < 300μs, Duty Cycle < 2.0%</li>
 See "SyncFET Schottky body diode characteristics" below.

FDP7030BLS/FDB7030BLS



FDP7030BLS/FDB7030BLS

FDP7030BLS Rev B(W)



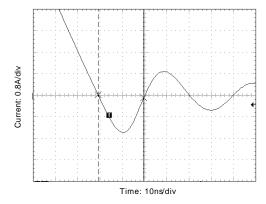
# FDP7030BLS/FDB7030BLS

FDP7030BLS Rev B(W)

# Typical Characteristics (continued)

# SyncFET Schottky Body Diode Characteristics

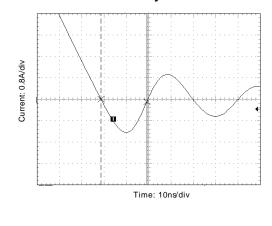
Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 12 FDP7030BLS.



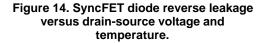
# Figure 12. FDP7030BLS SyncFET body diode reverse recovery characteristic.

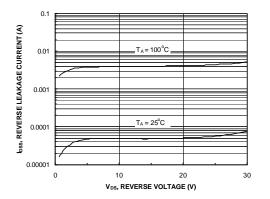
For comparison purposes, Figure 13 shows the reverse recovery characteristics of the body diode of an equivalent size MOSFET produced without SyncFET (FDP7030BL).

# Figure 13. Non-SyncFET (FDP7030BL) body diode reverse recovery characteristic.



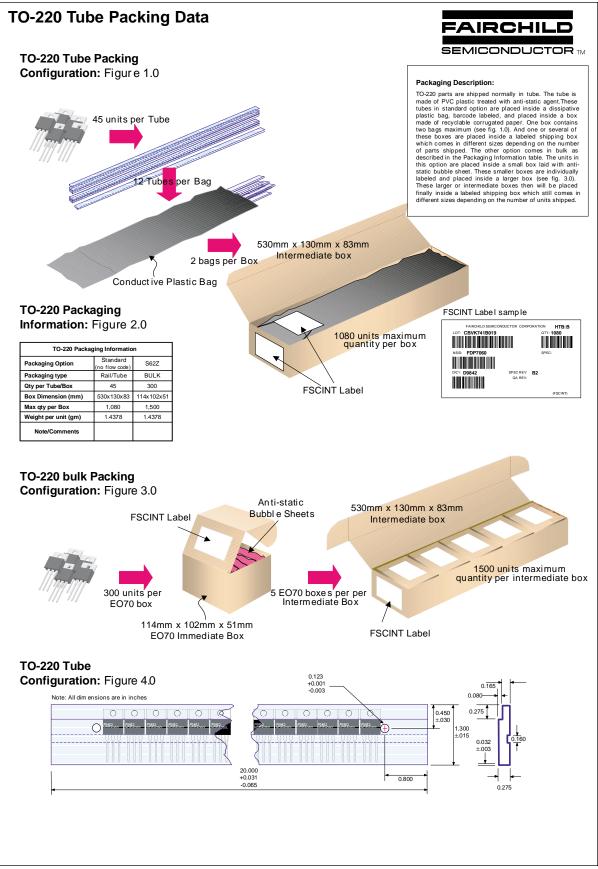
Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

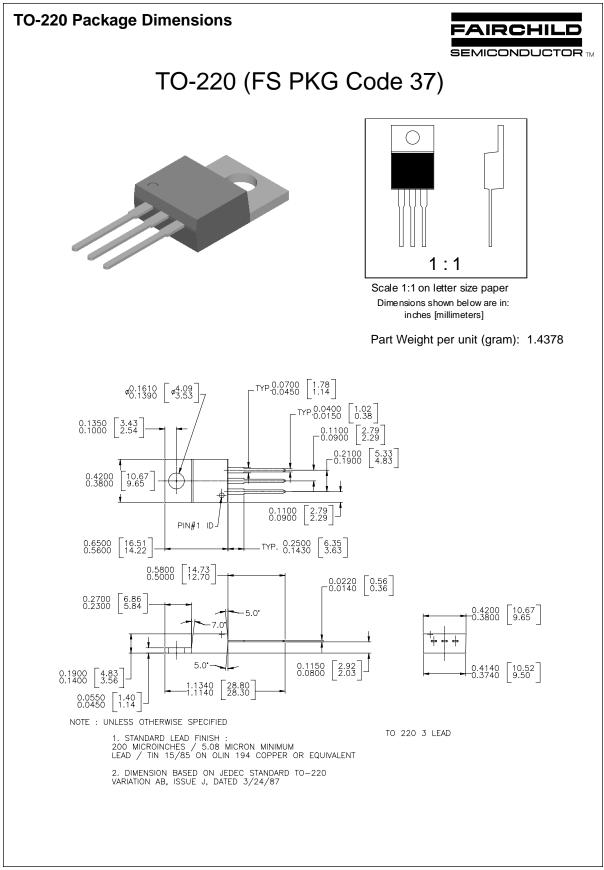


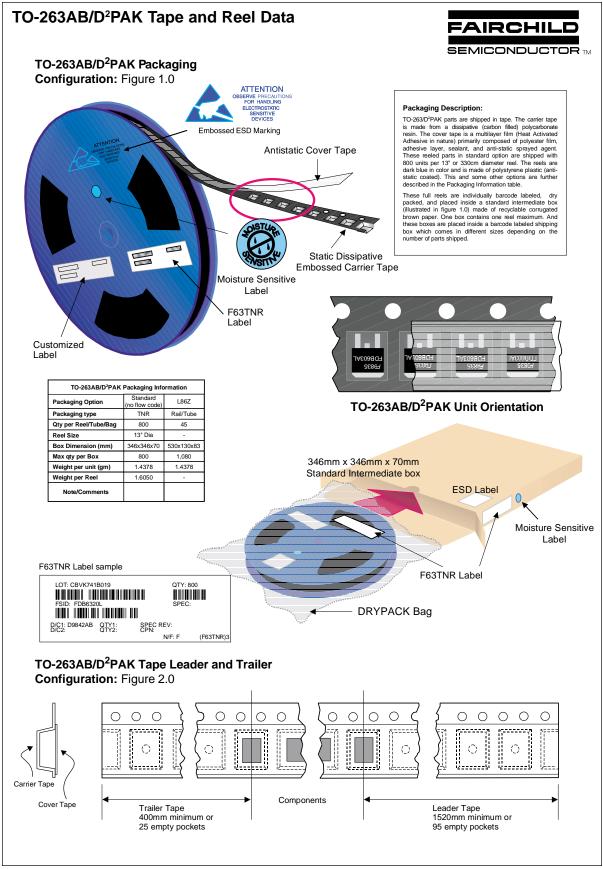


# FDP7030BLS/FDB7030BLS

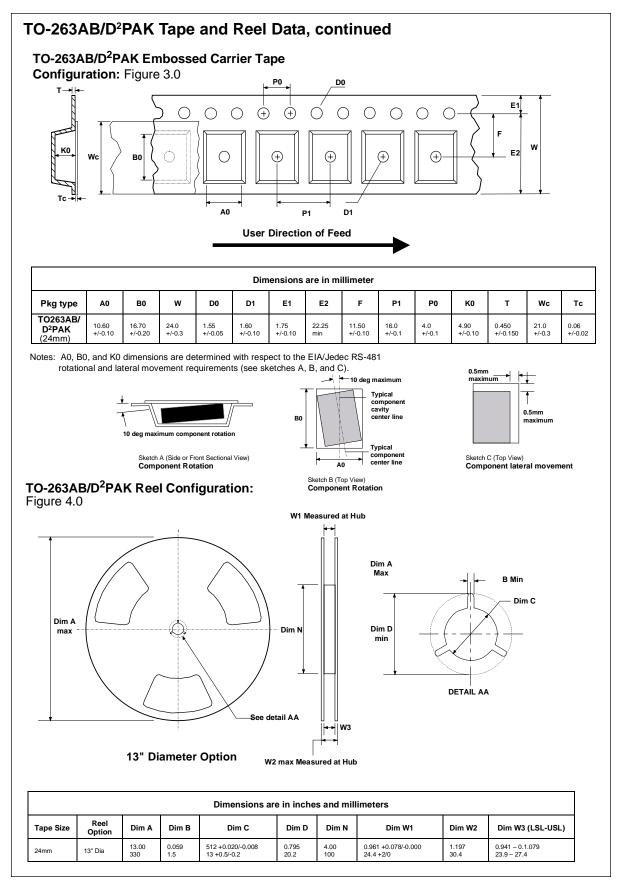
FDP7030BLS Rev B(W)

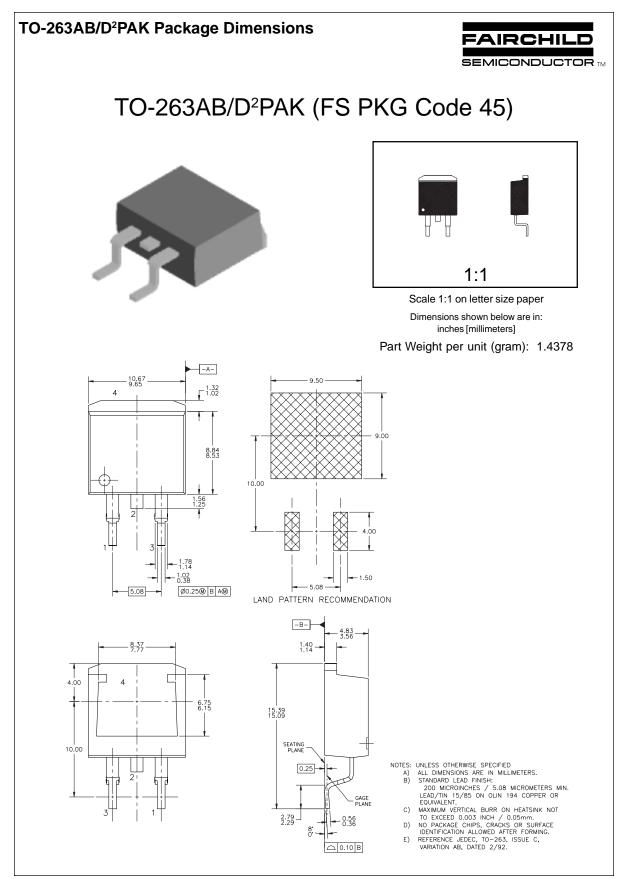






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